

Surface Mount Ultrafast Power Rectifiers

MURA215, SURA8215, MURA220, NRVUA220V, SURA8220

Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes in surface mount applications where compact size and weight are critical to the system.

Features

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- High Temperature Glass Passivated Junction
- Low Forward Voltage Drop (0.77 V Max @ 2.0 A, T_I = 150°C)
- Low Forward Voltage Drop (0.71 V Max @ 1.0 A, T_J = 150°C)
- NRVUA and SURA8 Prefixes for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable*
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 70 mg (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Polarity Band Indicates Cathode Lead
- ESD Protection:
 - Human Body Model > 4000 V (Class 3)
 - ◆ Charged Device Model > 1000 V (Class C5)

ULTRAFAST RECTIFIERS 2 AMPERES, 150-200 VOLTS



MARKING DIAGRAM



U5x = Device Code

x = C for MURA215 = D for MURA220

A = Assembly Location**

Y = Year WW = Work Week ■ = Pb-Free Package

** The Assembly Location Code (A) is front side optional. In cases where the Assembly Location is stamped in the package bottom (molding ejecter pin), the front side assembly code may be blank.

ORDERING INFORMATION

Device	Package	Shipping [†]
MURA215T3G		
SURA8215T3G*		
SURA8215T3G-VF01*	SMA (Pb-Free)	5,000 / Tape & Reel
MURA220T3G		
NRVUA220VT3G*		
SURA8220T3G*		

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage MURA215T3G/SURA8215T3G/SURA8215T3G-VF01 MURA220T3G/SURA8220T3G/NRVUA220VT3G	V _{RRM} V _{RWM} V _R	150 200	V
Average Rectified Forward Current @ T _L = 155°C @ T _L = 135°C	I _{F(AV)}	1.0 2.0	А
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	40	Α
Operating Junction Temperature Range	TJ	-65 to +175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Lead (T _L = 25°C) (Note 1)	Psi _{JL} (Note 2)	24	°C/W
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{\theta JA}$	216	

^{1.} Rating applies when surface mounted on the minimum pad size recommended, PC Board FR-4.

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (Note 3) ($i_F = 2.0 \text{ A}, T_J = 25^{\circ}\text{C}$) ($i_F = 2.0 \text{ A}, T_J = 150^{\circ}\text{C}$)	V _F	0.95 0.77	V
Maximum Instantaneous Reverse Current (Note 3) (Rated DC Voltage, T _J = 25°C) (Rated DC Voltage, T _J = 150°C)	i _R	2.0 50	μА
Maximum Reverse Recovery Time (i _F = 1.0 A, di/dt = 50 A/μs)	t _{rr}	35	ns

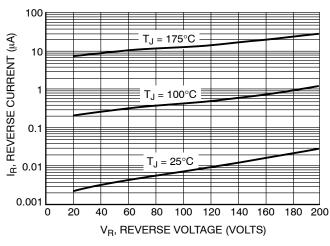
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

^{2.} In compliance with JEDEC 51, these values (historically represented by $R_{\theta JL}$) are now referenced as Psi_{JL}.

^{3.} Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.

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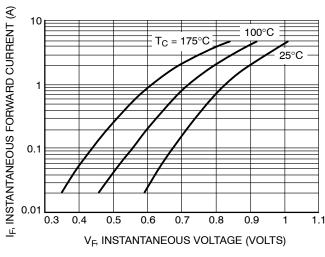
TYPICAL CHARACTERISTICS



100 T_J = 175°C 100 T_J = 100°C T_J = 25°C 0.1 0 20 40 60 80 100 120 140 160 180 200 V_R, REVERSE VOLTAGE (VOLTS)

Figure 1. Typical Reverse Current

Figure 2. Maximum Reverse Current



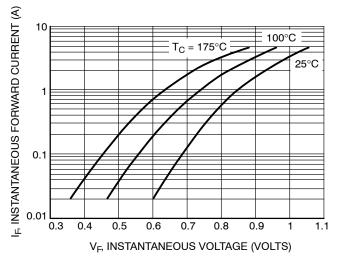


Figure 3. Typical Forward Voltage

Figure 4. Maximum Forward Voltage

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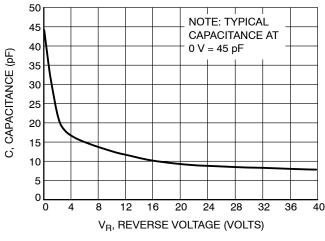


Figure 5. Typical Capacitance

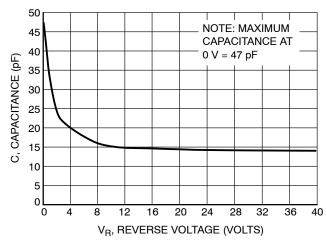


Figure 6. Maximum Capacitance

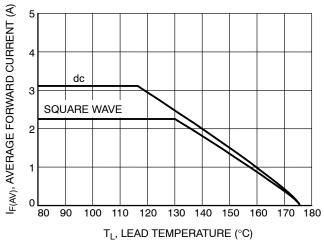


Figure 7. Current Derating, Lead

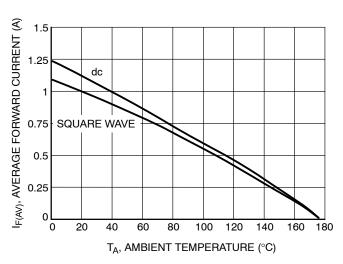


Figure 8. Current Derating, Ambient (FR-4 Board with Minimum Pad)

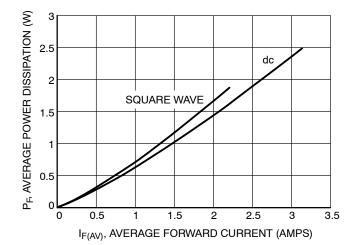


Figure 9. Power Dissipation

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS





HE

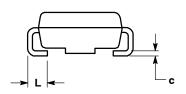
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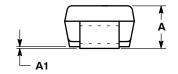
SMA CASE 403D ISSUE H

DATE 23 SEP 2015

- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M,
- 1982. CONTROLLING DIMENSION: INCH.
- DIMENSION b SHALL BE MEASURED WITHIN DIMENSION L.

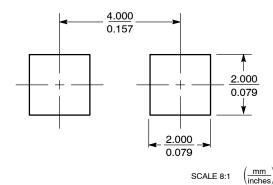
	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	1.97	2.10	2.20	0.078	0.083	0.087
A1	0.05	0.10	0.20	0.002	0.004	0.008
b	1.27	1.45	1.63	0.050	0.057	0.064
С	0.15	0.28	0.41	0.006	0.011	0.016
D	2.29	2.60	2.92	0.090	0.103	0.115
E	4.06	4.32	4.57	0.160	0.170	0.180
HE	4.83	5.21	5.59	0.190	0.205	0.220
L	0.76	1.14	1.52	0.030	0.045	0.060





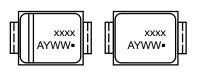
SOLDERING FOOTPRINT*

POLARITY INDICATOR OPTIONAL AS NEEDED (SEE STYLES)



^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM*



STYLE 1

STYLE 2

= Specific Device Code XXXX = Assembly Location Α

Υ = Year ww = Work Week = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

STYLE 1: PIN 1. CATHODE (POLARITY BAND)

STYLE 2: NO POLARITY

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